## $2.25 \mathrm{MHz}, 300 \mathrm{~mA}$ Synchronous Step-Down Regulator in SC70

## feATURES

- High Efficiency: Up to 96\%
- 300mA Output Current at $V_{I N}=3 \mathrm{~V}$
- 380mA Minimum Peak Switch Current
- 2.5V to 5.5V Input Voltage Range
- 2.25MHz Constant Frequency Operation
- No Schottky Diode Required

■ Low Dropout Operation: 100\% Duty Cycle

- Stable with Ceramic Capacitors
- 0.8V Reference Allows Low Output Voltages
- Shutdown Mode Draws <1ヶA Supply Current
- $\pm 2 \%$ Output Voltage Accuracy
- Current Mode Operation for Excellent Line and Load Transient Response
- Overtemperature Protected
- Available in Low Profile SC70 Package


## APPLICATIONS

- Cellular Telephones
- Personal Information Appliances
- Wireless and DSL Modems
- Digital Still Cameras
- MP3 Players
- Portable Instruments


## DESCRIPTIOn

The LTC ${ }^{\circledR} 3410 \mathrm{~B}$ is a high efficiency monolithic synchronous buck regulator using a constant frequency, current mode architecture. The device is available in adjustable and fixed output voltage versions. Supply current during operation is only $200 \mu \mathrm{~A}$, dropping to $<1 \mu \mathrm{~A}$ in shutdown. The 2.5V to 5.5 V input voltage range makes the LTC3410B ideally suited for single Li-Ion battery-powered applications. 100\% duty cycle provides low dropout operation, extending battery life in portable systems. PWM pulse skipping mode operation provides very low output ripple voltage for noise sensitive applications.
Switching frequency is internally set at 2.25 MHz , allowing the use of small surface mount inductors and capacitors. The LTC3410B is specifically designed to work well with ceramic output capacitors, achieving very low output voltage ripple and a small PCB footprint.
The internal synchronous switch increases efficiency and eliminates the need for an external Schottky diode. Low output voltages are easily supported with the 0.8 V feedback reference voltage. The LTC3410B is available in a tiny, low profile SC70 package.
$\boldsymbol{\Omega}$, LT, LTC and LTM are registered trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners. Protected by U.S. Patents, including 5481178, 5994885, 6580258, 6304066, 6127815, 6498466, 6611131.

## TYPICAL APPLICATION



Efficiency and Power Loss vs Output Current


## ABSOLUTE MAXIMUUM RATInGS (Note 1)

| Input Supply Voltage .............................. -0.3V to 6V | Peak SW Sink and Source Current ................... 630mA |
| :---: | :---: |
| RUN, $\mathrm{V}_{\text {FB }}$ Voltages ................................ -0.3 V to $\mathrm{V}_{\text {IN }}$ | Operating Temperature Range (Note 2) .. $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| SW Voltage (DC) ....................... -0.3 V to ( $\mathrm{V}_{\text {IN }}+0.3 \mathrm{~V}$ ) | Junction Temperature (Note 3) ......................... $125^{\circ} \mathrm{C}$ |
| P-Channel Switch Source Current (DC) ............ 500 mA | Storage Temperature Range ............... $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| N-Channel Switch Sink Current (DC) ................ 500mA | Lead Temperature (Soldering, 10 sec )............... $300^{\circ} \mathrm{C}$ |

## PACKAGE/ORDER INFORMATION

|  |  | TOP VIEW |  |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
|  |  | 1 | $\square 6 \mathrm{~V}_{\text {Out }}$ |
| GND 2 | 75 GND | 2 | $\square 5 \mathrm{GND}$ |
| SW | $\square 4 \mathrm{~V}_{\text {IN }}$ | SW3 | $\square \mathrm{V}_{1 /}$ |
| Sc6 PACKAGE 6-LEAD PLASTIC SC70 |  | SC6 PACKAGE 6-LEAD PLASTIC SC70 |  |
| $T_{\text {Jmax }}=125^{\circ} \mathrm{C}, \theta_{J J}=250^{\circ} \mathrm{C} / \mathrm{W}$ |  | $T_{\text {Jmax }}=125^{\circ} \mathrm{C}, \theta_{J A}=250^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| ORDER PART NUMBER | SC6 PART MARKING | ORDER PART NUMBER | SC6 PART MARKING |
| LTC3410BESC6 | LBZY | LTC3410BESC6-1.2 | LCMX |
|  |  | LTC3410BESC6-1.5 | LCMY |
|  |  | LTC3410BESC6-1.8 | LCMZ |
|  |  | LTC3410BESC6-1.875 | LCHZ |

Order Options Tape and Reel: Add \#TR
Lead Free: Add \#PBF Lead Free Tape and Reel: Add \#TRPBF
Lead Free Part Marking: http://www.linear.com/leadfree/
Consult LTC Marketing for parts specified with wider operating temperature ranges.

## ELECTRICAL CHARACTERISTICS

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$V_{I N}=3.6 \mathrm{~V}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{\text {VFBB }}$ | Feedback Current | Adjustable Output Voltage | $\bullet$ |  |  | $\pm 30$ | nA |
| IVOut | Output Voltage Feedback Current | Fixed Output Voltage | $\bullet$ |  | 3.3 | 6 | $\mu \mathrm{A}$ |
| IPK | Peak Inductor Current | $\mathrm{V}_{\text {IN }}=3 \mathrm{~V}, \mathrm{~V}_{\text {FB }}=0.7 \mathrm{~V}$ or $\mathrm{V}_{\text {OUT }}=90 \%$, Duty Cycle $<35 \%$ |  | 380 | 490 | 600 | mA |
| $\mathrm{V}_{\text {FB }}$ | Regulated Feedback Voltage | Adjustable Output Voltage (LTC3410BE) | $\bullet$ | 0.784 | 0.8 | 0.816 | V |
| - $\mathrm{V}_{\mathrm{FB}}$ | Reference Voltage Line Regulation | $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to 5.5 V | $\bullet$ |  | 0.04 | 0.4 | \%/V |
| $\mathrm{V}_{\text {OUT }}$ | Regulated Output Voltage | LTC3410B-1.2, $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ LTC3410B-1.5, $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ LTC3410B-1.8, $I_{\text {OUT }}=100 \mathrm{~mA}$ LTC3410B-1.875, $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | $\stackrel{\bullet}{\bullet}$ | $\begin{gathered} 1.176 \\ 1.47 \\ 1.764 \\ 1.837 \end{gathered}$ | $\begin{gathered} 1.2 \\ 1.5 \\ 1.8 \\ 1.875 \end{gathered}$ | $\begin{gathered} 1.224 \\ 1.53 \\ 1.836 \\ 1.913 \end{gathered}$ | V V V V |
| $\Delta \mathrm{V}_{\text {OUT }}$ | Output Voltage Line Regulation | $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to 5.5 V | $\bullet$ |  | 0.04 | 0.4 | \%/V |
| V LOADREG | Output Voltage Load Regulation | $\mathrm{L}_{\text {LOAD }}=50 \mathrm{~mA}$ to 250 mA |  |  | 0.5 |  | \% |
| $\mathrm{V}_{\text {IN }}$ | Input Voltage Range |  | $\bullet$ | 2.5 |  | 5.5 | V |
| VUVLO | Undervoltage Lockout Threshold | $V_{\text {IN }}$ Rising <br> $V_{\text {IN }}$ Falling |  |  | $\begin{gathered} 2.0 \\ 1.94 \end{gathered}$ | 2.3 | V |
|  |  |  |  |  |  |  | 3410bfa |

## ELECTRICAL CHARACTERISTICS

The $\bullet$ denotes specifications which apply over the full operating temperature range, otherwise specifications are $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$V_{I N}=3.6 \mathrm{~V}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Is | Input DC Bias Current Operating Shutdown | (Note 4) $\begin{aligned} & \mathrm{V}_{\text {FB }}=0.83 \mathrm{~V} \text { or } \mathrm{V}_{\text {OUT }}=104 \%, \mathrm{I}_{\text {LOAD }}=0 \mathrm{~A} \\ & \mathrm{~V}_{\text {RUN }}=0 \mathrm{~V} \end{aligned}$ |  |  | $\begin{gathered} 200 \\ 0.1 \end{gathered}$ | $\begin{gathered} 300 \\ 1 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| $\mathrm{f}_{\text {OSC }}$ | Oscillator Frequency | $\begin{aligned} & V_{\text {FB }}=0.8 \mathrm{~V} \text { or } V_{\text {OUT }}=100 \% \\ & V_{\text {FB }}=0 \mathrm{~V} \text { or } V_{\text {OUT }}=0 \mathrm{~V} \end{aligned}$ | $\bullet$ | 1.8 | $\begin{aligned} & 2.25 \\ & 310 \\ & \hline \end{aligned}$ | 2.7 | $\begin{array}{r} \mathrm{MHz} \\ \mathrm{kHz} \\ \hline \end{array}$ |
| RPFET | $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ of P-Channel FET | $\mathrm{I}_{\text {SW }}=100 \mathrm{~mA}$ |  |  | 0.75 | 0.9 | $\Omega$ |
| $\mathrm{R}_{\text {NFET }}$ | $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ of N -Channel FET | $\mathrm{I}_{\text {SW }}=-100 \mathrm{~mA}$ |  |  | 0.55 | 0.7 | $\Omega$ |
| ILSW | SW Leakage | $\mathrm{V}_{\text {RUN }}=0 \mathrm{~V}, \mathrm{~V}_{\text {SW }}=0 \mathrm{~V}$ or $5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5 \mathrm{~V}$ |  |  | $\pm 0.01$ | $\pm 1$ | $\mu \mathrm{A}$ |
| VRUN | RUN Threshold |  | $\bullet$ | 0.3 | 1 | 1.5 | V |
| IRUN | RUN Leakage Current |  | $\bullet$ |  | $\pm 0.01$ | $\pm 1$ | $\mu \mathrm{A}$ |

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.
Note 2: The LTC3410BE is guaranteed to meet performance specifications from $0^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. Specifications over the $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ operating temperature range are assured by design, characterization and correlation with statistical process controls.
Note 3: $T_{j}$ is calculated from the ambient temperature $T_{A}$ and power dissipation $P_{D}$ according to the following formula:

LTC3410B: $T_{J}=T_{A}+\left(P_{D}\right)\left(250^{\circ} \mathrm{C} / \mathrm{W}\right)$

Note 4: Dynamic supply current is higher due to the gate charge being delivered at the switching frequency.
Note 5: This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed $125^{\circ} \mathrm{C}$ when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

## TYPICAL PERFORMANCE CHARACTERISTICS

(From Figure 1 Except for the Resistive Divider Resistor Values)


## TYPICAL PERFORMANCE CHARACTERISTICS

(From Figure 1 Except for the Resistive Divider Resistor Values)


## TYPICAL PGRFORMANCE CHARACTGRISTICS

(From Figure 1 Except for the Resistive Divider Resistor Values)


## PIn functions

RUN (Pin 1): Run Control Input. Forcing this pin above 1.5 V enables the part. Forcing this pin below 0.3 V shuts down the device. In shutdown, all functions are disabled drawing <1 $\mu$ A supply current. Do not leave RUN floating. GND (Pins 2, 5): Ground Pin.
SW (Pin 3): Switch Node Connection to Inductor. This pin connects to the drains of the internal main and synchronous power MOSFET switches.
$V_{\text {IN }}$ (Pin 4): Main Supply Pin. Must be closely decoupled to GND, Pin 2, with a $2.2 \mu \mathrm{~F}$ or greater ceramic capacitor.
$V_{\text {FB }}$ (Pin 6 on Adjustable Version): Feedback Pin. Receives the feedback voltage from an external resistive divider across the output.
$V_{\text {OUT }}$ (Pin 6 on Fixed Voltage Versions): Output Voltage Feedback Pin. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage.

## fUnCTIONAL DIAGRAM



## OPGRATIOी (Refer to Functional Diagram)

## Main Control Loop

The LTC3410B uses a constant frequency, current mode step-down architecture. Both the main (P-channel MOSFET) and synchronous (N-channel MOSFET) switches are internal. During normal operation, the internal top power MOSFET is turned on each cycle when the oscillator sets the RS latch, and turned off when the current comparator, ICOMP, resets the RS latch. The peak inductor current at which I COMP resets the RS latch, is controlled by the output of error amplifier EA. The $V_{F B}$ pin, described in the Pin Functions section, allows EA to receive an output feedback voltage from an external resistive divider. When the load current increases, it causes a slight decrease in the feedback voltage relative to the 0.8 V reference, which in turn, causes the EA amplifier's output voltage to increase until the average inductor current matches the new load current. While the top MOSFET is off, the bottom MOSFET is turned on until either the inductor current starts to reverse, as indicated by the current reversal comparator $I_{\text {RCMP }}$, or the beginning of the next clock cycle.

## Pulse Skipping Mode Operation

At light loads, the inductor current may reach zero or reverse on each pulse. The bottom MOSFET is turned off by the current reversal comparator, $I_{\text {RCMP }}$, and the switch voltage will ring. This is discontinuous mode operation, and is normal behavior for the switching regulator. At very light loads, the LTC3410B will automatically skip pulses in pulse skipping mode operation to maintain output regulation. Refer to LTC3410 data sheet if Burst Mode ${ }^{\circledR}$ operation is preferred.

## Short-Circuit Protection

When the output is shorted to ground, the frequency of the oscillator is reduced to about 310kHz, 1/7 the nominal
frequency. This frequency foldback ensures that the inductor current has moretime to decay, thereby preventing runaway. The oscillator's frequency will progressively increase to 2.25 MHz when $\mathrm{V}_{\text {FB }}$ rises above 0 V .

## Dropout Operation

As the input supply voltage decreases to a value approaching the output voltage, the duty cycle increases toward the maximum on-time. Further reduction of the supply voltage forces the main switch to remain on for more than one cycle until it reaches $100 \%$ duty cycle. The output voltage will then be determined by the input voltage minus the voltage drop across the P-channel MOSFET and the inductor.

Another important detail to remember is that at low input supply voltages, the $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of the P -channel switch increases (see Typical Performance Characteristics). Therefore, the user should calculate the power dissipation when the LTC3410B is used at $100 \%$ duty cycle with low input voltage (See Thermal Considerations in the Applications Information section).

## Slope Compensation and Inductor Peak Current

Slope compensation provides stability in constant frequency architectures by preventing subharmonic oscillations at high duty cycles. It is accomplished internally by adding a compensating ramp to the inductor current signal at duty cycles in excess of $40 \%$. Normally, this results in a reduction of maximum inductor peak current for duty cycles $>40 \%$. However, the LTC3410B uses a patented scheme that counteracts this compensating ramp, which allows the maximum inductor peak current to remain unaffected throughout all duty cycles.

Burst Mode is a Registered Trademark of Linear Technology Corporation.

APPLICATIONS InFORMATION


Figure 1. High Efficiency Step-Down Converter

The basic LTC3410B application circuit is shown in Figure 1. External component selection is driven by the load requirement and begins with the selection of $L$ followed by $\mathrm{C}_{\text {IN }}$ and $\mathrm{C}_{\text {OUT }}$.

## Inductor Selection

For most applications, the value of the inductor will fall in the range of $2.2 \mu \mathrm{H}$ to $4.7 \mu \mathrm{H}$. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher $V_{\text {IN }}$ or $V_{\text {OUT }}$ also increases the ripple current as shown in Equation 1. A reasonable starting point for setting ripple current is $\Delta L_{L}=120 \mathrm{~mA}(40 \%$ of 300 mA$)$.

$$
\begin{equation*}
\Delta \mathrm{L}_{\mathrm{L}}=\frac{1}{(\mathrm{f})(\mathrm{L})} \mathrm{V}_{\text {OUT }}\left(1-\frac{\mathrm{V}_{\text {OUT }}}{\mathrm{V}_{\mathrm{IN}}}\right) \tag{1}
\end{equation*}
$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 360 mA rated inductor should be enough for most applications ( 300 mA $+60 \mathrm{~mA})$. For better efficiency, choose a low DC-resistance inductor.

## Inductor Core Selection

Different core materials and shapes will change the size/ current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or permalloy materials are small and don't radiate much energy, but generally cost more than powdered iron core inductors with similar electrical characteristics. The choice of which style inductor to use often depends more on the price vs size requirements and any radiated field/EMI requirements than on what the LTC3410B requires to operate. Table 1 shows some typical surface mount inductors that work well in LTC3410B applications.

Table 1. Representative Surface Mount Inductors

|  |  |  | MAX DC |  |  |
| :--- | :--- | :---: | :---: | :---: | :---: |
| MANUFACTURER | PART NUMBER | VALUE | CURRENT | DCR | HEIGHT |
| Taiyo Yuden | CB2016T2R2M | $2.2 \mu \mathrm{H}$ | 510 mA | $0.13 \Omega$ | 1.6 mm |
|  | CB2012T2R2M | $2.2 \mu \mathrm{H}$ | 530 mA | $0.33 \Omega$ | 1.25 mm |
|  | LBC2016T3R3M | $3.3 \mu \mathrm{H}$ | 410 mA | $0.27 \Omega$ | 1.6 mm |
| Panasonic | ELT5KT4R7M | $4.7 \mu \mathrm{H}$ | 950 mA | $0.2 \Omega$ | 1.2 mm |
| Sumida | CDRH2D18/LD | $4.7 \mu \mathrm{H}$ | 630 mA | $0.086 \Omega$ | 2 mm |
| Murata | LQH32CN4R7M23 | $4.7 \mu \mathrm{H}$ | 450 mA | $0.2 \Omega$ | 2 mm |
| Taiyo Yuden | NR30102R2M | $2.2 \mu \mathrm{H}$ | 1100 mA | $0.1 \Omega$ | 1 mm |
|  | NR30104R7M | $4.7 \mu \mathrm{H}$ | 750 mA | $0.19 \Omega$ | 1 mm |
| FDK | FDKMIPF2520D | $4.7 \mu \mathrm{H}$ | 1100 mA | $0.11 \Omega$ | 1 mm |
|  | FDKMIPF2520D | $3.3 \mu \mathrm{H}$ | 1200 mA | $0.1 \Omega$ | 1 mm |
|  | FDKMIPF2520D | $2.2 \mu \mathrm{H}$ | 1300 mA | $0.08 \Omega$ | 1 mm |

## $\mathrm{C}_{\text {IN }}$ and $\mathrm{C}_{\text {OUt }}$ Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle $\mathrm{V}_{\text {OUT }} / V_{\text {IN }}$. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:
$C_{\text {IN }}$ required $I_{\text {RMS }} \cong I_{\text {OMAX }} \frac{\left[V_{\text {OUT }}\left(V_{\text {IN }}-V_{\text {OUT }}\right)\right]^{1 / 2}}{V_{\text {IN }}}$

## APPLICATIONS INFORMATION

This formula has a maximum at $\mathrm{V}_{I N}=2 \mathrm{~V}_{\text {OUT }}$, where $I_{\text {RMS }}=I_{\text {OUT }} / 2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Always consult the manufacturer if there is any question.
The selection of $\mathrm{C}_{\text {OUT }}$ is driven by the required effective series resistance (ESR). Typically, once the ESR requirement for $\mathrm{C}_{\text {OUT }}$ has been met, the RMS current rating generally far exceeds the $I_{\text {RIPPLE(P-P) }}$ requirement. The output ripple $\Delta \mathrm{V}_{\text {OUT }}$ is determined by:

$$
\Delta \mathrm{V}_{\text {OUT }} \cong \Delta \mathrm{l}_{\mathrm{L}}\left(\mathrm{ESR}+\frac{1}{8 \mathrm{f} \mathrm{C}_{\text {OUT }}}\right)
$$

where $f=$ operating frequency, $C_{\text {OUT }}=$ output capacitance and $\Delta I_{L}=$ ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since $\Delta l_{L}$ increases with input voltage.
If tantalum capacitors are used, it is critical that the capacitors are surge tested for use in switching power supplies. An excellent choice is the AVX TPS series of surface mount tantalum. These are specially constructed and tested for low ESR so they give the lowest ESR for a given volume. Other capacitor types include Sanyo POSCAP, Kemet T510 and T495 series, and Sprague 593D and 595D series. Consult the manufacturer for other specific recommendations.

## Using Ceramic Input and Output Capacitors

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Because the LTC3410B's control loop does not depend on the output capacitor's ESR for stable operation, ceramic capacitors can be used freely to achieve very low output ripple and small circuit size.

However, care must be taken when ceramic capacitors are used at the input and the output. When a ceramic capacitor is used at the input and the power is supplied by a wall adapter through long wires, a load step at the output can induce ringing at the input, $\mathrm{V}_{\text {IN }}$. At best, this ringing can couple to the output and be mistaken as loop instability. At worst, a sudden inrush of current through the long wires can potentially cause a voltage spike at $\mathrm{V}_{\mathrm{IN}}$, large enough to damage the part.
When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

## Output Voltage Programming (LTC3410B Only)

The output voltage is set by a resistive divider according to the following formula:

$$
\begin{equation*}
V_{\text {OUT }}=0.8 \mathrm{~V}\left(1+\frac{\mathrm{R} 2}{\mathrm{R} 1}\right) \tag{2}
\end{equation*}
$$

The external resistive divider is connected to the output, allowing remote voltage sensing as shown in Figure 2.


Figure 2. Setting the LTC3410B Output Voltage

## APPLICATIONS InFORMATION

## Efficiency Considerations

The efficiency of a switching regulator is equal to the output power divided by the input powertimes $100 \%$. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Efficiency can be expressed as:

$$
\text { Efficiency }=100 \%-(L 1+L 2+L 3+\ldots)
$$

where L1, L2, etc. are the individual losses as a percentage of input power.

Although all dissipative elements in the circuit produce losses, two main sources usually account for most of the Iosses in LTC3410B circuits: $V_{\text {IN }}$ quiescent current and $I^{2} R$ losses. The $\mathrm{V}_{\text {IN }}$ quiescent current loss dominates the efficiency loss at very low load currents whereas the $I^{2} R$ loss dominates the efficiency loss at medium to high load currents. In a typical efficiency plot, the efficiency curve at very low load currents can be misleading since the actual power lost is of no consequence as illustrated in Figure 3.

1. The $\mathrm{V}_{\text {IN }}$ quiescent current is due to two components: the DC bias current as given in the electrical characteristics and the internal main switch and synchronous switch gate charge currents. The gate charge current results from switching the gate capacitance of the internal power MOSFET switches. Each time the gate is switched from high to low to high again, a packet of
charge, dQ, moves from $V_{\text {IN }}$ to ground. The resulting $d Q / d t$ is the current out of $V_{\text {IN }}$ that is typically larger than the DC bias current. In continuous mode, $I_{G A T E C H G}=f\left(Q_{T}+Q_{B}\right)$ where $Q_{T}$ and $Q_{B}$ are the gate charges of the internal top and bottom switches. Both the DC bias and gate charge losses are proportional to $\mathrm{V}_{\text {IN }}$ and thustheir effectswill be more pronounced at higher supply voltages.
2. $I^{2} R$ losses are calculated from the resistances of the internal switches, $R_{S W}$, and external inductor $\mathrm{R}_{\mathrm{L}}$. In continuous mode, the average output current flowing through inductor $L$ is "chopped" between the main switch and the synchronous switch. Thus, the series resistance looking into the SW pin is a function of both top and bottom MOSFET $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ and the duty cycle (DC) as follows:

$$
R_{S W}=\left(R_{D S(O N) T O P)}(D C)+\left(R_{D S(O N) B O T)}\right)(1-D C)\right.
$$

The $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ for both the top and bottom MOSFETs can be obtained from the Typical Performance Charateristics curves. Thus, to obtain I ${ }^{2}$ R losses, simply add $\mathrm{R}_{\text {Sw }}$ to $R_{L}$ and multiply the result by the square of the average output current.
Other losses including $\mathrm{C}_{\mathrm{IN}}$ and $\mathrm{C}_{\text {OUT }}$ ESR dissipative losses and inductor core losses generally account for less than 2\% total additional loss.


Figure 3. Power Lost vs Load Current

## APPLICATIONS INFORMATION

## Thermal Considerations

In most applications the LTC3410B does not dissipate much heat due to its high efficiency. But, in applications where the LTC3410B is running at high ambient temperature with low supply voltage and high duty cycles, such as in dropout, the heat dissipated may exceed the maximum junction temperature of the part. If the junction temperature reaches approximately $150^{\circ} \mathrm{C}$, both power switches will be turned off and the SW node will become high impedance.
To avoid the LTC3410B from exceeding the maximum junction temperature, the user will need to do some thermal analysis. The goal of the thermal analysis is to determine whether the power dissipated exceeds the maximum junction temperature of the part. The temperature rise is given by:

$$
T_{R}=\left(P_{D}\right)\left(\theta_{\mathrm{JA}}\right)
$$

where $P_{D}$ is the power dissipated by the regulator and $\theta_{\mathrm{Ja}}$ is the thermal resistance from the junction of the die to the ambient temperature.
The junction temperature, $T_{J}$, is given by:

$$
T_{J}=T_{A}+T_{R}
$$

where $T_{A}$ is the ambient temperature.
As an example, consider the LTC3410B in dropout at an input voltage of 2.7 V , a load current of 300 mA and an ambient temperature of $70^{\circ} \mathrm{C}$. From the typical performance graph of switch resistance, the $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of the P-channel switch at $70^{\circ} \mathrm{C}$ is approximately $1.0 \Omega$. Therefore, power dissipated by the part is:

$$
P_{D}=I_{L O A D}{ }^{2} \cdot R_{D S(O N)}=90 \mathrm{~mW}
$$

For the SC70 package, the $\theta_{\mathrm{JA}}$ is $250^{\circ} \mathrm{C} / \mathrm{W}$. Thus, the junction temperature of the regulator is:

$$
\mathrm{T}_{J}=70^{\circ} \mathrm{C}+(90)(250)=92.5^{\circ} \mathrm{C}
$$

which is well below the maximum junction temperature of $125^{\circ} \mathrm{C}$.
Note that at higher supply voltages, the junction temperature is lower due to reduced switch resistance ( $\left.\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}\right)$.

## Checking Transient Response

The regulator loop response can be checked by looking at the load transient response. Switching regulators take several cycles to respond to a step in load current. When a load step occurs, Vout immediately shifts by an amount equal to ( $\Delta L_{\text {LOAD }} \bullet E S R$ ), where ESR is the effective series resistance of COUT. $\Delta$ l LOAD also begins to charge or discharge $\mathrm{C}_{0 \mathrm{ut}}$, which generates a feedback error signal. The regulator loop then acts to return $\mathrm{V}_{\text {OUT }}$ to its steadystate value. During this recovery time $\mathrm{V}_{\text {OUT }}$ can be monitored for overshoot or ringing that would indicate a stability problem. For a detailed explanation of switching control loop theory, see Application Note 76.
A second, more severe transient is caused by switching in loads with large ( $>1 \mu \mathrm{~F}$ ) supply bypass capacitors. The discharged bypass capacitors are effectively put in parallel with $\mathrm{C}_{\text {OUT }}$, causing a rapid drop in $\mathrm{V}_{\text {OUT }}$. No regulator can deliver enough current to prevent this problem if the load switch resistance is low and it is driven quickly. The only solution is to limit the rise time of the switch drive so that the load rise time is limited to approximately ( $25 \cdot \mathrm{C}_{\text {LOAD }}$ ). Thus, a 10 $\mu \mathrm{F}$ capacitor charging to 3.3 V would require a $250 \mu \mathrm{~s}$ rise time, limiting the charging current to about 130 mA .

## APPLICATIONS InFORMATION

## PC Board Layout Checklist

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the LTC3410B. These items are also illustrated graphically in Figures 4 and 5. Check the following in your layout:

1. The power traces, consisting of the GND trace, the SW trace and the $\mathrm{V}_{\text {IN }}$ trace should be kept short, direct and wide.


Figure 4a. LTC3410B Layout Diagram


Figure 5a. LTC3410B Suggested Layout
2. Does the $\mathrm{V}_{\mathrm{FB}}$ pin connect directly to the feedback resistors? The resistive divider R1/R2 must be connected between the $(+)$ plate of $\mathrm{C}_{\text {OUt }}$ and ground.
3. Does the ( + ) plate of $\mathrm{C}_{\text {IN }}$ connect to $\mathrm{V}_{\text {IN }}$ as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
4. Keep the $(-)$ plates of $\mathrm{C}_{\text {IN }}$ and $\mathrm{C}_{\text {OUt }}$ as close as possible.
5. Keep the switching node, SW, away from the sensitive $V_{\text {FB }}$ node.


Figure 4b. LTC3410B-1.875 Layout Diagram


Figure 5b. LTC3410B Fixed Output Voltage Suggested Layout

## APPLICATIONS InFORMATION

## Design Example

As a design example, assume the LTC3410B is used in a single lithium-ion battery-powered cellular phone application. The $V_{I N}$ will be operating from a maximum of 4.2 V down to about 2.7 V . The load current requirement is a maximum of 0.3 A but most of the time it will be in standby mode, requiring only 2 mA . Efficiency at both low and high load currents is important. Output voltage is 2.5 V . With this information we can calculate L using Equation (1),

$$
\begin{equation*}
L=\frac{1}{(f)\left(\Delta I_{L}\right)} V_{\text {OUT }}\left(1-\frac{V_{\text {OUT }}}{V_{I N}}\right) \tag{3}
\end{equation*}
$$

Substituting $\mathrm{V}_{\text {OUT }}=2.5 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=4.2 \mathrm{~V}, \Delta \mathrm{~L}_{\mathrm{L}}=100 \mathrm{~mA}$ and $\mathrm{f}=2.25 \mathrm{MHz}$ in Equation (3) gives:

For best efficiency choose a 300 mA or greater inductor with less than $0.3 \Omega$ series resistance.
$\mathrm{C}_{\text {In }}$ will require an RMS current rating of at least $0.125 \mathrm{~A} \cong$ $\mathrm{I}_{\text {LOAD(MAX) }} / 2$ at temperature and $\mathrm{C}_{\text {Out }}$ will require an ESR of less than $0.5 \Omega$. In most cases, a ceramic capacitor will satisfy this requirement.

For the feedback resistors, choose R1 $=412 \mathrm{k}$. R2 can then be calculated from equation (2) to be:

$$
\mathrm{R} 2=\left(\frac{\mathrm{V}_{\text {OUT }}}{0.8}-1\right) \mathrm{R} 1=875.5 \mathrm{k} \text {; use } 887 \mathrm{k}
$$

Figure 6 shows the complete circuit along with its efficiency curve.

$$
\mathrm{L}=\frac{2.5 \mathrm{~V}}{2.25 \mathrm{MHz}(100 \mathrm{~mA})}\left(1-\frac{2.5 \mathrm{~V}}{4.2 \mathrm{~V}}\right)=4.5 \mu \mathrm{H}
$$



Figure 6a


Figure 6b


Figure 6c

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## TYPICAL APPLICATION


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## PACKAGE DESCRIPTION

## SC6 Package

 6-Lead Plastic SC70(Reference LTC DWG \# 05-08-1638)


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## TYPICAL APPLICATION

## Using Low Profile Components, <1mm Height



## RELATGD PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| LT1616 | 500 mA (I Iout), 1.4 MHz , High Efficiency Step-Down DC/DC Converter | $90 \%$ Efficiency, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ to $25 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=1.25 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=1.9 \mathrm{~mA}$, $I_{S D}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LTC1877 | 600 mA (IOUT), 550 kHz , Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{I N}=2.7 \mathrm{~V}$ to $10 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=10 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS8 Package |
| LTC1878 | 600 mA (I ${ }_{\text {Out }}$ ), 550 kHz , Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ to $6 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=10 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS8 Package |
| LTC1879 | 1.2A (I ${ }_{\text {Out }}$ ), 550kHz, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ to $10 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=15 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, TSSOP-16 Package |
| LTC3403 | 600 mA (Iout), 1.5MHz, Synchronous Step-Down DC/DC Converter with Bypass Transistor | $96 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=$ Dynamically Adjustable, $\mathrm{I}_{\mathrm{Q}}=20 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, DFN Package |
| LTC3404 | 600 mA (I ${ }_{\text {Out }}$ ), 1.4MHz, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.7 \mathrm{~V}$ to $6 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=10 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}, \mathrm{MS} 8$ Package |
| LTC3405/LTC3405A | 300 mA (IOUT), 1.5MHz, Synchronous Step-Down DC/DC Converter | $96 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=20 \mu \mathrm{~A}$, $I_{S D}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LTC3406 | 600 mA (lout), 1.5 MHz , Synchronous Step-Down DC/DC Converter | $96 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.6 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=20 \mu \mathrm{~A}$, $I_{S D}=<1 \mu \mathrm{~A}$, ThinSOT Package |
| LTC3407/LTC3407-2 | Dual $600 \mathrm{~mA} / 800 \mathrm{~mA}$ (I lout), $1.5 \mathrm{MHz} / 2.25 \mathrm{MHz}$, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.6 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=40 \mu \mathrm{~A}$, $I_{S D}=<1 \mu A$, DFN, MS10E Packages |
| LTC3409 | 600 mA (Iout), $1.5 \mathrm{MHz} / 2.25 \mathrm{MHz}$, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=1.6 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN })}=0.613 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=65 \mu \mathrm{~A}$, DD8 Package |
| LTC3410 | 300 mA (IOUT), 2.25 MHz , Synchronous Step-Down DC/DC Converter with Burst Mode Operation | $96 \%$ Efficiency, $\mathrm{V}_{\mathrm{IN}}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=26 \mu \mathrm{~A}$, $I_{S D}=<1 \mu \mathrm{~A}$, SC70 Package |
| LTC3411 | 1.25A (Iout), 4MHz, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=60 \mu \mathrm{~A}$, $\mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS Package |
| LTC3412/LTC3412A | 2.5A/3A (Iout), 4MHz, Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\mathrm{IN}}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=60 \mu \mathrm{~A}$, $I_{S D}=<1 \mu \mathrm{~A}$, TSSOP-16E Package |
| LTC3440 | 600 mA (Iout), 2MHz, Synchronous Buck-Boost DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=2.5 \mathrm{~V}$ to 5 V , $\mathrm{I}_{\mathrm{Q}}=25 \mu \mathrm{~A}, \mathrm{I}_{\mathrm{SD}}=<1 \mu \mathrm{~A}$, MS Package |
| LTC3548 | Dual $400 \mathrm{~mA} / 800 \mathrm{~mA}$ (Iout), 2.25 MHz , Synchronous Step-Down DC/DC Converter | $95 \%$ Efficiency, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {OUT(MIN) }}=0.6 \mathrm{~V}, \mathrm{I}_{\mathrm{Q}}=40 \mu \mathrm{~A}$, $I_{S D}=<1 \mu A$, DFN, MS10E Packages |

